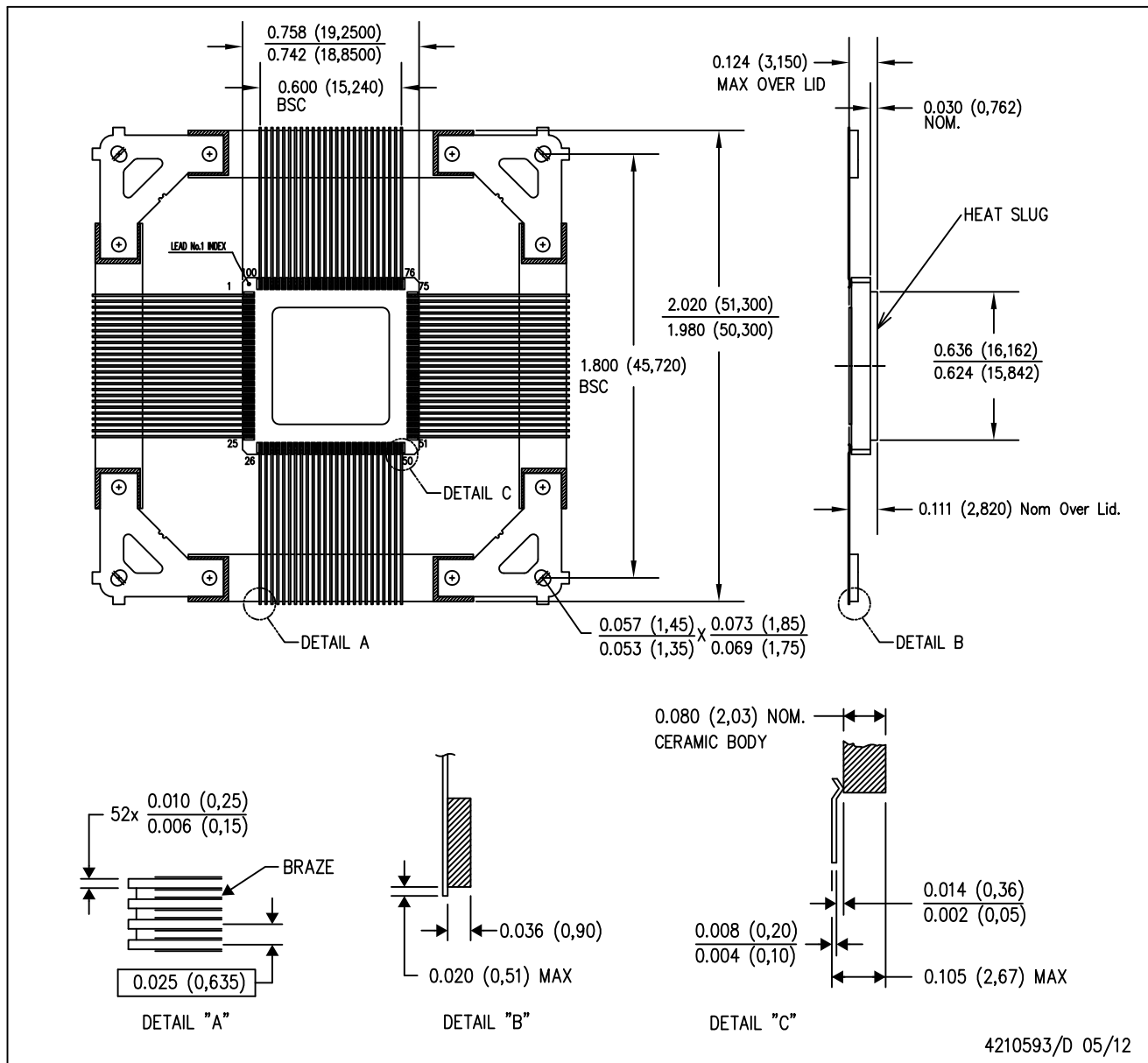


HFS (S-CQFP-F100)

CERAMIC QUAD FLATPACK WITH NCTB



- NOTES:
- A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Ceramic quad flatpack with flat leads brazed to non-conductive tie bar carrier.
  - D. This package is hermetically sealed with a metal lid.
  - E. The leads are gold plated and can be solderdipped.
  - F. Leads not shown for clarity purposes.
  - G. Lid and heat sink are connected to GND leads.

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